



Product Change Notification

Change Notification #: 118768-00
Change Title: Intel® RAID Adapter RSP3WD080E,
PCN 118768-00, Product Design,
Change in PCB Layout
Date of Publication: December 08, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*	December 23, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes:

- Change in PCB layout to allow alternate PSoC options.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® RAID Adapter RSP3WD080E	RSP3WD080E	954495	J55265-007	J40743-205	J55265-008	J40743-206

PCN Revision History:

Date of Revision: December 08, 2021	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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